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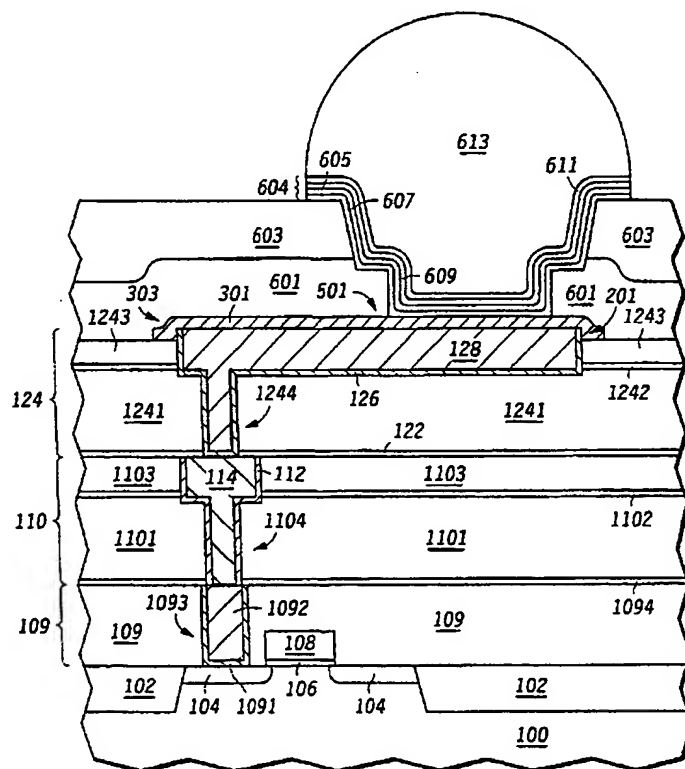
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- (71) Applicant: MOTOROLA, INC. [US/US]; 1303 East Algonquin Road, Schaumburg, IL 60196 (US).
- (72) Inventors: SHROFF, Mehul, D.; 4105 Victory Drive, #D-102, Austin, TX 78704 (US). GRIGG, Philip, G.; 1901 Clay Lane, Cedar Park, TX 78613 (US).
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[Continued on next page]

(54) Title: SEMICONDUCTOR DEVICE AND METHOD OF FORMATION



(57) Abstract: A semiconductor device and its method of formation are disclosed wherein a surface of a semiconductor substrate is planarized to form an interconnect (1244) within a dielectric layer (1243). The top surface of the dielectric layer is then recessed with respect to a top surface of the interconnect to form a step (201). An opaque film (301) is then deposited over the surface of the semiconductor substrate. The opaque film (301) is lithographically patterned and etched, wherein an alignment of the patterning layer (401) is accomplished using topographically discernable features (303) that are formed in the opaque film (301) in regions where the step (201) between the interconnect (1244) and dielectric layer (1243) is produced.

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According to International Patent Classification (IPC) or to both national classification and IPC

B. FIELDS SEARCHED

Minimum documentation searched (classification system followed by classification symbols)

IPC 7 H01L

Documentation searched other than minimum documentation to the extent that such documents are included in the fields searched

Electronic data base consulted during the international search (name of data base and, where practical, search terms used)

EPO-Internal, WPI Data, PAJ

C. DOCUMENTS CONSIDERED TO BE RELEVANT

Category *	Citation of document, with indication, where appropriate, of the relevant passages	Relevant to claim No.
X	US 5 863 825 A (OSUGI RICHARD ET AL) 26 January 1999 (1999-01-26) column 2, line 42 -column 3, line 14 column 3, line 48 -column 4, line 5; figures 2,5,6	1,5
X A	WO 99 08314 A (OKAMOTO YOSHIHIKO ;HITACHI LTD (JP)) 18 February 1999 (1999-02-18) abstract page 20, line 24 -page 22, line 16 page 23, line 22 -page 24, line 13 page 25, line 10 -page 26, line 22 page 33, line 23 -page 36, line 9 page 40, line 24 -page 45, line 17 page 52, line 22 -page 54, line 14; figures 9-13,18-21,23-26,33-41,48-58,76-81 -/-	1 2-4,6-10

☒ Further documents are listed in the continuation of box C.

☒ Patent family members are listed in annex.

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Name and mailing address of the ISA

European Patent Office, P.B. 5818 Patentlaan 2
NL - 2280 HV Rijswijk
Tel. (+31-70) 340-2040, Tx. 31 651 epo nl.
Fax: (+31-70) 340-3016

Authorized officer

Micke, K

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C.(Continuation) DOCUMENTS CONSIDERED TO BE RELEVANT

Category *	Citation of document, with indication, where appropriate, of the relevant passages	Relevant to claim No.
X A	US 6 020 263 A (YU CHEN-HUA ET AL) 1 February 2000 (2000-02-01) column 3, line 64 -column 5, line 43; claim 1; figures 7A,8,9 -----	1 5,9

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Form PCT/ISA/210 (continuation of second sheet) (July 1992)

INTERNATIONAL SEARCH REPORT

Information on patent family members

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US 5863825	A	26-01-1999	JP	11186162 A	09-07-1999
WO 9908314	A	18-02-1999	WO	9908314 A1	18-02-1999
US 6020263	A	01-02-2000	NONE		

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